

## LM837 Low Noise Quad Operational Amplifier

### General Description

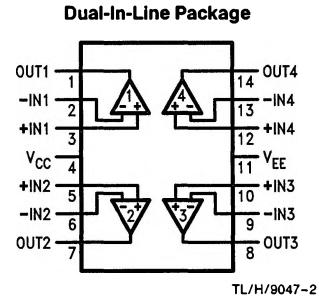
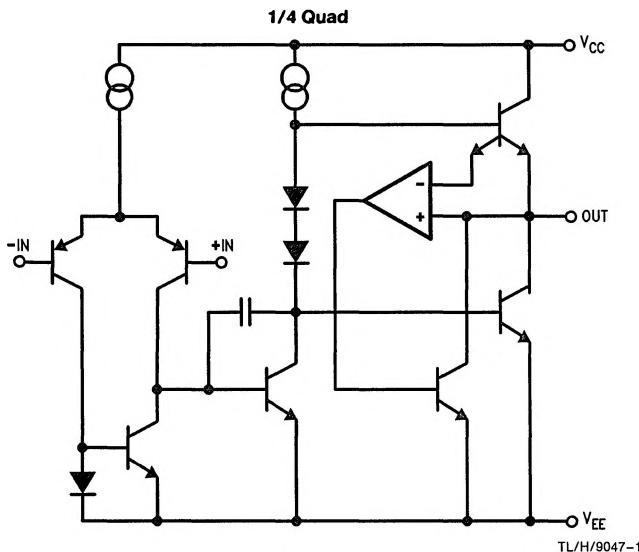
The LM837 is a quad operational amplifier designed for low noise, high speed and wide bandwidth performance. It has a new type of output stage which can drive a  $600\Omega$  load, making it ideal for almost all digital audio, graphic equalizer, pre-amplifiers, and professional audio applications. Its high performance characteristics also make it suitable for instrumentation applications where low noise is the key consideration.

The LM837 is internally compensated for unity gain operation. It is pin compatible with most other standard quad op amps and can therefore be used to upgrade existing systems with little or no change.

### Features

- High slew rate  $10 \text{ V}/\mu\text{s}$  (typ)  
 $8 \text{ V}/\mu\text{s}$  (min)
- Wide gain bandwidth product  $25 \text{ MHz}$  (typ)  
 $15 \text{ MHz}$  (min)
- Power bandwidth  $200 \text{ kHz}$  (typ)
- High output current  $\pm 40 \text{ mA}$   
 $> 600\Omega$
- Excellent output drive performance  $4.5 \text{ nV}/\sqrt{\text{Hz}}$
- Low input noise voltage  $0.0015\%$
- Low total harmonic distortion  $0.3 \text{ mV}$
- Low offset voltage

### Schematic and Connection Diagrams



Order Number LM837M or LM837N  
See NS Package Number M14A or  
N14A

## Absolute Maximum Ratings

If Military/Aerospace specified devices are required, contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage	$V_{CC}/V_{EE}$	$\pm 18V$
Differential Input Voltage (Note 1)	$V_{ID}$	$\pm 30V$
Common Mode Input Voltage (Note 1)	$V_{IC}$	$\pm 15V$
Power Dissipation (Note 2)	$P_D$	1.2W (N) 830 mW (M)
Operating Temperature Range	$T_{OPR}$	-40°C to +85°C
Storage Temperature Range	$T_{STG}$	-60°C to +150°C

### Soldering Information

Dual-In-Line Package

Soldering (10 seconds)

260°C

Small Outline Package

Vapor Phase (60 seconds)

215°C

Infrared (15 seconds)

220°C

ESD rating is to be determined.

See AN-450 "Surface Mounting Methods and Their Effect on Product Reliability" for other methods of soldering surface mount devices.

## DC Electrical Characteristics $T_A = 25^\circ C, V_S = \pm 15V$

Symbol	Parameter	Condition	Min	Typ	Max	Units
$V_{OS}$	Input Offset Voltage	$R_S = 50\Omega$		0.3	5	mV
$I_{OS}$	Input Offset Current			10	200	nA
$I_B$	Input Bias Current			500	1000	nA
$A_V$	Large Signal Voltage Gain	$R_L = 2 k\Omega, V_{OUT} = \pm 10V$	90	110		dB
$V_{OM}$	Output Voltage Swing	$R_L = 2 k\Omega$	$\pm 12$	$\pm 13.5$		V
		$R_L = 600\Omega$	$\pm 10$	$\pm 12.5$		V
$V_{CM}$	Common Mode Input Voltage		$\pm 12$	$\pm 14.0$		V
$CMRR$	Common Mode Rejection Ratio	$V_{IN} = \pm 12V$	80	100		dB
$PSRR$	Power Supply Rejection Ratio	$V_S = 15 \sim 5, -15 \sim -5$	80	100		dB
$I_S$	Power Supply Current	$R_L = \infty$ , Four Amps		10	15	mA

## AC Electrical Characteristics $T_A = 25^\circ C, V_S = \pm 15V$

Symbol	Parameter	Condition	Min	Typ	Max	Units
SR	Slew Rate	$R_L = 600\Omega$	8	10		$V/\mu s$
GBW	Gain Bandwidth Product	$f = 100 kHz, R_L = 600\Omega$	15	25		MHz

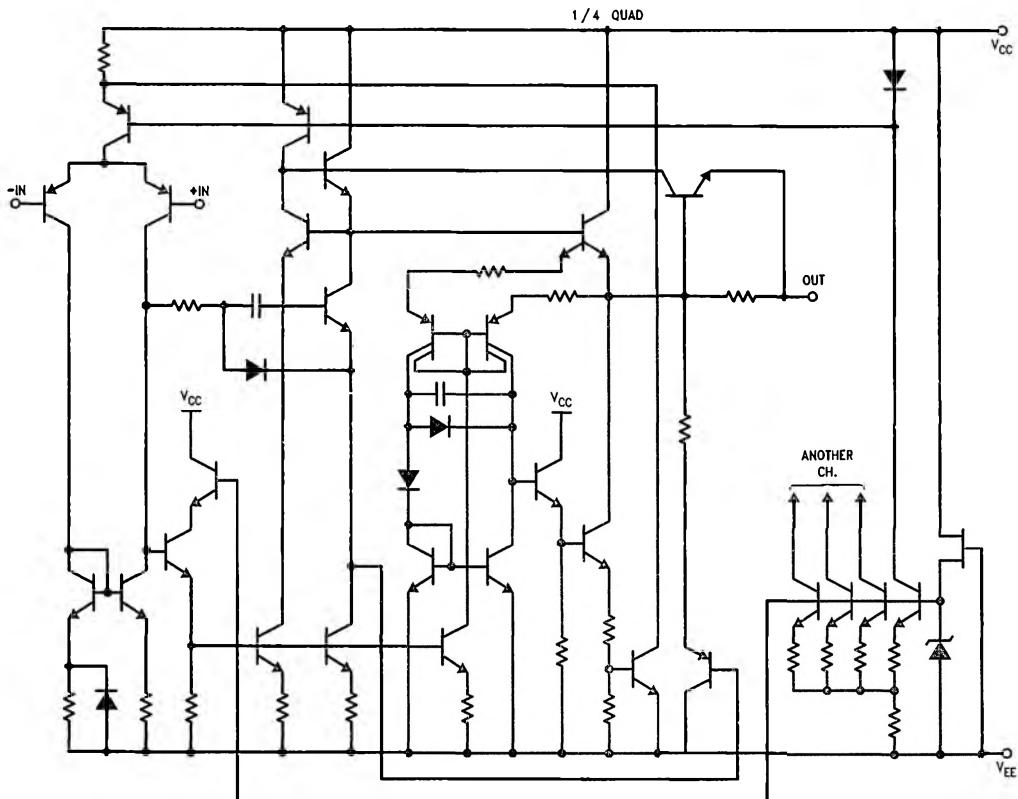
## Design Electrical Characteristics $T_A = 25^\circ C, V_S = \pm 15V$ (Note 3)

Symbol	Parameter	Condition	Min	Typ	Max	Units
PBW	Power Bandwidth	$V_O = 25 V_{P-P}, R_L = 600\Omega, THD < 1\%$		200		kHz
$e_{n1}$	Equivalent Input Noise Voltage	JIS A, $R_S = 100\Omega$		0.5		$\mu V$
$e_{n2}$	Equivalent Input Noise Voltage	$f = 1 kHz$		4.5		$nV/\sqrt{Hz}$
$i_n$	Equivalent Input Noise Current	$f = 1 kHz$		0.7		$pA/\sqrt{Hz}$
THD	Total Harmonic Distortion	$A_V = 1, V_{OUT} = 3 V_{rms}, f = 20 \sim 20 kHz, R_L = 600\Omega$		0.0015		%
$f_U$	Zero Cross Frequency	Open Loop		12		MHz
$\phi_m$	Phase Margin	Open Loop		45		deg
	Input-Referred Crosstalk	$f = 20 \sim 20 kHz$		-120		dB
$\Delta V_{OS}/\Delta T$	Average TC of Input Offset Voltage			2		$\mu V/^\circ C$

Note 1: Unless otherwise specified the absolute maximum input voltage is equal to the power supply voltage.

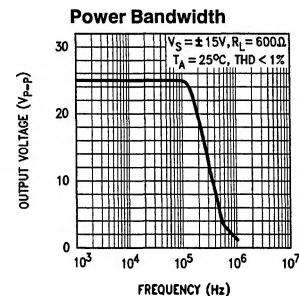
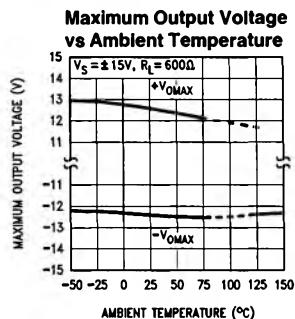
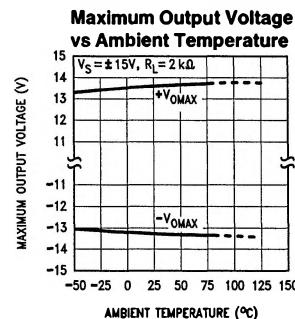
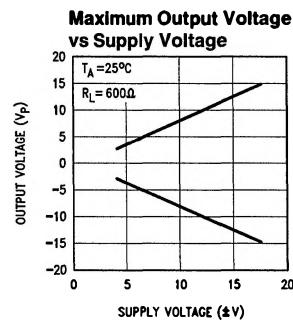
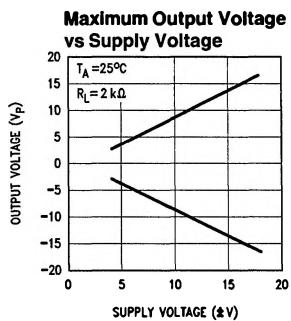
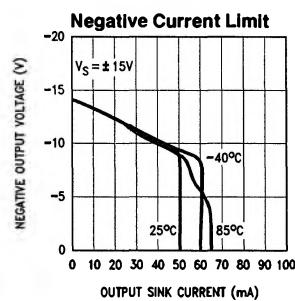
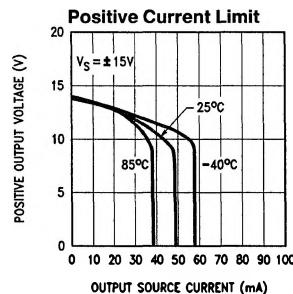
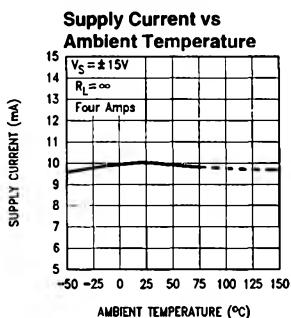
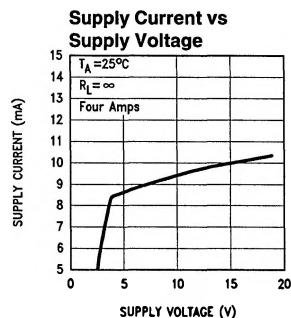
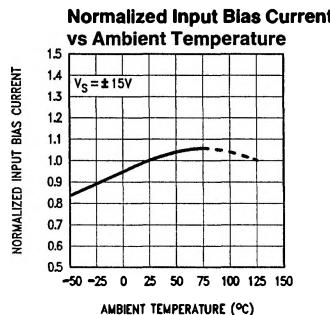
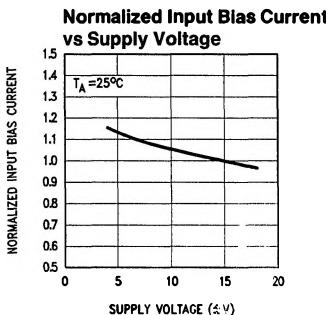
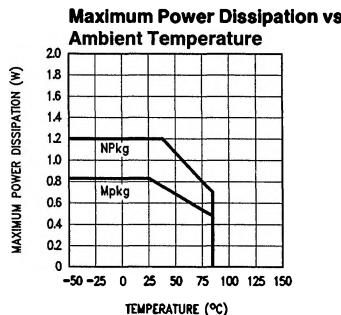
Note 2: For operation at ambient temperatures above 25°C, the device must be derated based on a 150°C maximum junction temperature and a thermal resistance, junction to ambient, as follows: LM837N, 90°C/C/W; LM837M, 150°C/C/W.

Note 3: The following parameters are not tested or guaranteed.

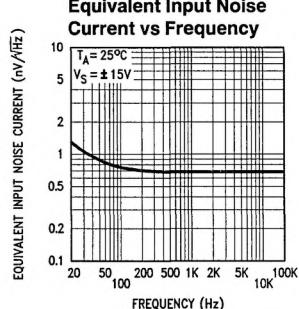
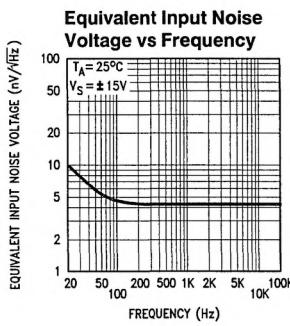
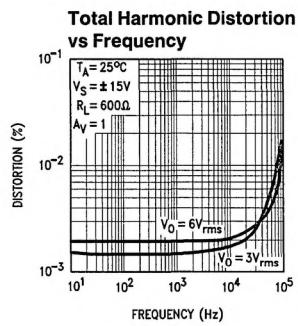
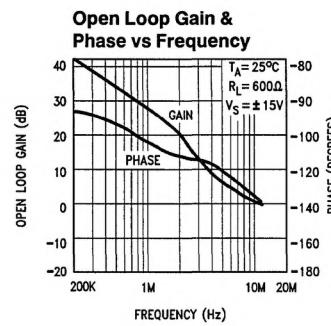
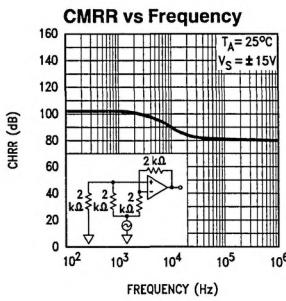
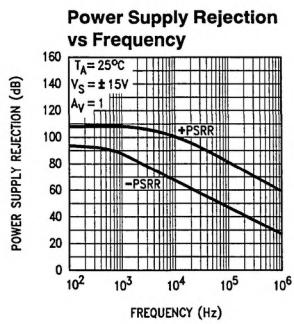
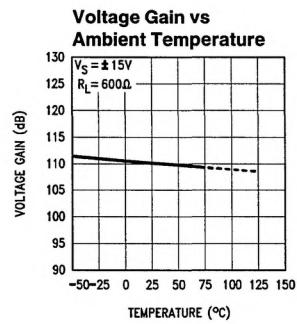
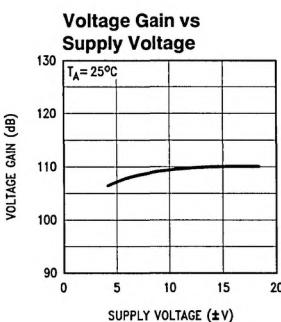
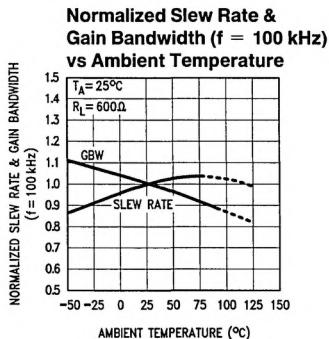
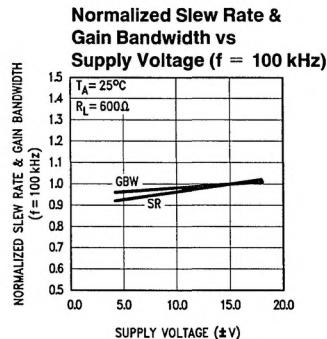
**Detailed Schematic**

TL/H/9047-3

## Typical Performance Characteristics



## Typical Performance Characteristics (Continued)



## Typical Performance Characteristics (Continued)

